

Docket No. TRANSMITTAL LETTER END920000094US1 (General - Patent Pending) David J. Alcoe Examiner Group Art Unit Serial No. Filing Date 09/714,373 11/16/00 Lindinger, M. 2841 Title: COMPLIANT LAMINATE CONNECTOR TO THE ASSISTANT COMMISSIONER FOR PATENTS: Transmitted herewith is: Amendment (15 pages) in the above identified application. No additional fee is required. \square A check in the amount of is attached. The Assistant Commissioner is hereby authorized to charge and credit Deposit Account No. 09-0457 (IBM) as described below. A duplicate copy of this sheet is enclosed. Charge the amount of Credit any overpayment. Charge any additional fee required. Dated: March 29, 2002 Signature Arlen L. Olsen Reg. No. 37,543 **SCHMEISER, OLSEN & WATTS**

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I certify that this document and fee is being deposited on 3/29/02 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Assistant Com hissioner for Patents, Washington, D.C. 20231.

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: David J. Alcoe) Examiner: Lindinger, M.)

Serial No.: 09/714,373) Art Unit: 2841

Filing Date: 11/16/00)

Commissioner for Patents Washington D.C. 20231

Title: COMPLIANT LAMINATE

Sir:

This paper is being filed in response to the Final Office Action dated March 11, 2002. Reconsideration and allowance are respectfully requested in view of the Remarks below, that each of the presently pending claims be allowed, and that the application be passed to issue.

AFTER FINAL AMENDMENT

IN THE SPECIFICATION

The following paragraph replaces the paragraph on page 6, line 12:

In particular, a large portion of the thermally created shear stress is spread throughout the length of the laminate 28, rather than being concentrated within the individual BGA connections 30.

The flexible nature of the laminate 28 is further enhanced by selectively placing critical BGA connections 30 in staggered or off-set or alternating positions on the top and bottom surfaces of the laminate 28. Note that not all BGA connections 30 need to be staggered to obtain an optimal solder

